

IDS - 01/03/2006 ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Elimination of RDL Using Tape Base Flip Chip on Flex for Die Stacking	
Application Number :	10/050507	
Confirmation Number:	7687	
First Named Applicant:	Teck Lee	
Attorney Docket Number:	MTI-31607	
Art Unit:	2813	
Examiner:	Jack SJ Chen	
Search string.	(6624060 or 20020027080 or 20030134450).pn	



US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

Init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DAZ	1	6624060	2003-09-23	Chen et al.		438	613

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

Init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
DAZ	1	20020027080	2002-03-07	Yoshioka et al.	A1	205	123
DAZ	2	20030134450	2003-07-17	Lee	A1	438	106

Signature

Examiner Name	Date
/David Zarneke/	05/22/2006

DS - 11/10/2005

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Elimination of RDL Using Tape Base Flip Chip on Flex for Die Stacking							
Application Number :	10/050507							
Confirmation Number:	7687							
First Named Applicant:	Teck Loo							
Attorney Docket Number:	MTI-31607							
Art Unit:	2813							
Examiner:	Jack SJ Chen							
Search string:	(6308525 or 5468995 or 6610559).pn							
US Patent Documents								
Note: Applicant is not required to submit a paper copy of cited US Patent Documents								
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	
DAZ	1	6308525	2001-03-27	Imasu et al.		361	783	
DAZ	2	5468995	1995-11-21	Higgins III		257	697	
DAZ	3	6610559	2003-08-26	Wang et al.		438	108	
Signature								
Examiner Name				Date				
/David Zarneke/				05/22/2006				

IDS - 11/25/2005 ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Elimination of RDk Using Tape Base Flip Chip on Flex for Die Stacking							
Application Number	10/050507							
Confirmation Number:	7687							
First Named Applicant:	Teck Lee							
Attorney Docket Number:	MTI-31607							
Art Unit:	2813							
Examiner:	Jack SJ Chen							
Search string:	(4415403 or 6847105).pn							
US Patent Documents								
Note: Applicant is not required to submit a paper copy of cited US Patent Documents								
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	
DAZ	1	4415403	1983-11-15	Bakewell		216	27	
DAZ	2	6847105	2005-01-25	Koopmans		257	686	
Signature								
Examiner Name				Date				
/David Zarneke/				05/22/2006				